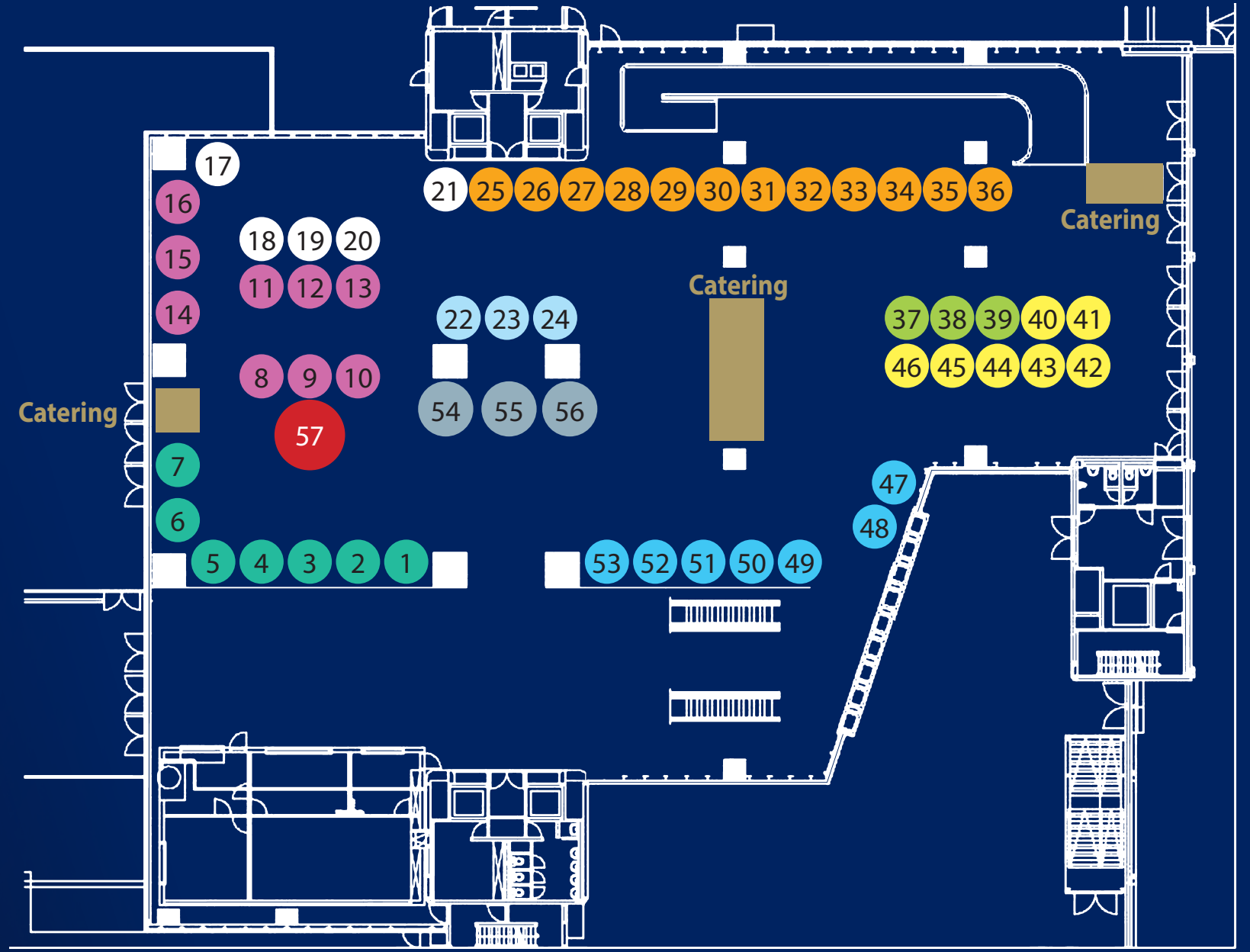


# FLOOR PLAN

## EXHIBIT CATEGORIES

- Power Electronics
- Systems Design and Integration
- Supporting Initiatives
- Sustainable Electronics
- Embedded Intelligence
- Pilot Lines
- Advanced Nodes and Heterogeneous Integration
- Sensors and Devices
- AENEAS, EPOSS, INSIDE Industry Associations
- Chips JU



### EXHIBITORS

<b>1</b>	GaN4AP
<b>2</b>	Powerized
<b>3</b>	All2GaN
<b>4</b>	TRANSFORM
<b>5</b>	HiEFFICIENT
<b>6</b>	R-PODID
<b>7</b>	R3POWERUP
<b>8</b>	AIDOaRt
<b>9</b>	Arrowhead_fPVN
<b>10</b>	FEDERATE
<b>11</b>	TRISTAN
<b>12</b>	ISOLDE
<b>13</b>	OPEVA
<b>14</b>	Resilient Trust
<b>15</b>	RETICLES
<b>16</b>	NEUROKIT2E
<b>17</b>	Cyberagentur
<b>18</b>	IDEAL-IST
<b>19</b>	ICOS
<b>20</b>	HiPEAC
<b>21</b>	ECSA
<b>22</b>	SUSTRONICS
<b>23</b>	ARCHIMEDES
<b>24</b>	EECONE

### EXHIBITORS

<b>25</b>	AI4CSM
<b>26</b>	AIMS5.0
<b>27</b>	SC4EU
<b>28</b>	EdgeAI
<b>29</b>	EcoMobility
<b>30</b>	CLEVER
<b>31</b>	StorAlge
<b>32</b>	A-IQ Ready
<b>33</b>	DAIS
<b>34</b>	AI-Twilight
<b>35</b>	REBECCA
<b>36</b>	H2TRAIN
<b>37</b>	Pilot line 1 - NanoIC
<b>38</b>	Pilot line 2 - FAMES
<b>39</b>	Pilot line 3 - APECS
<b>40</b>	photonixFAB
<b>41</b>	HICONNECTS
<b>42</b>	SHIFT
<b>43</b>	MATq
<b>44</b>	More Moore (10Åce, 14AMI, ID2PPAC, 14CMOS)
<b>45</b>	More Moore (10Åce, 14AMI, ID2PPAC, 14CMOS)
<b>46</b>	More Moore (10Åce, 14AMI, ID2PPAC, 14CMOS)

### EXHIBITORS

<b>47</b>	NerveRepack
<b>48</b>	AGRARSENSE
<b>49</b>	BRIGHTER
<b>50</b>	LoLiPoP IoT
<b>51</b>	iRel40
<b>52</b>	Listen2Future
<b>53</b>	Move2THz
<b>54</b>	AENEAS IA
<b>55</b>	EPoSS IA
<b>56</b>	INSIDE IA
<b>57</b>	Chips JU